

(SMALL-SIGNAL DIODE)

MC2832

FOR HIGH SPEED SWITCHING APPLICATION
SILICON EPITAXIAL TYPE

DESCRIPTION

MC2832 is a super mini package plastic seal type silicon epitaxial type diode, especially designed for high speed switching application.

Due to the small pin capacitance, short switching time (reverse recovery time), it is most suitable for high speed switching application and limiter, clipper application.

FEATURE

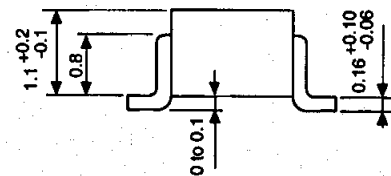
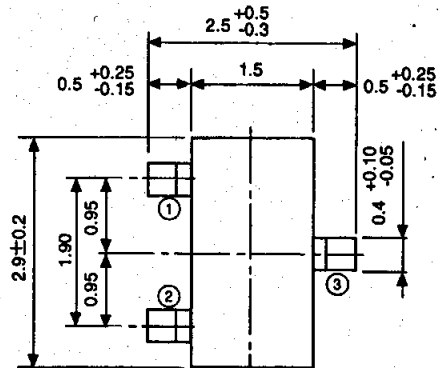
- Small pin capacitance
- Quick switching time
- Small outline package for mounting
- High voltage
- Super mini package for mounting

APPLICATION

For general high speed switching of audio machine, VCR.

OUTLINE DRAWING

Unit:mm

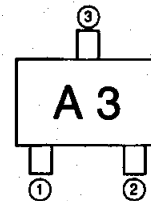


TERMINAL CONNECTOR

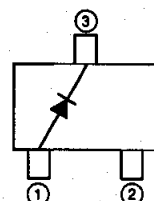
- ① : ANODE
 - ② : NC
 - ③ : CATHODE
- EIAJ : SC-59
JEDEC : TO-236 resemblance

Note) The dimension without tolerance represent central value.

MARKING



INTERNAL CONNECTION



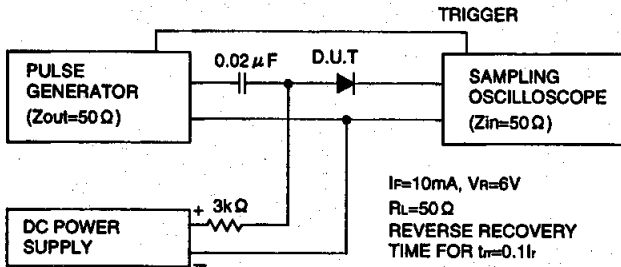
MAXIMUM RATINGS (Ta=25°C)

| Symbol | Parameter | Ratings | Unit |
|------------------|--------------------------------------|-------------|------|
| V _{RM} | Peak reverse voltage | 75 | V |
| V _R | DC reverse voltage | 50 | V |
| I _{FSM} | Surge current(1 μs) | 4 | A |
| I _{FM} | Peak forward current | 300 | mA |
| I _O | Average rectification current | 100 | mA |
| P _T | Total allowable dissipation(Ta=25°C) | 150 | mW |
| T _J | Junction temperature | +125 | °C |
| T _{stg} | Storage temperature | -55 to +125 | °C |

ELECTRICAL CHARACTERISTICS (Ta=25°C)

| Symbol | Parameter | Test conditions | Limits | | | Unit |
|-----------------|-----------------------|------------------------------|--------|------|-----|------|
| | | | Min | Typ | Max | |
| V _{F1} | Forward voltage | I _F = 10mA | | 0.68 | 0.9 | V |
| V _{F2} | Forward voltage | I _F = 50mA | | 0.82 | 1.0 | V |
| V _{F3} | Forward voltage | I _F = 100mA | | 0.92 | 1.2 | V |
| I _R | Reverse current | V _R = 50V | | | 0.1 | μA |
| C _i | Pin capacitance | V _R = 0, f = 1MHz | | 1.3 | 4.0 | pF |
| t _{rr} | Reverse recovery time | (Refer to test circuit) | | | 4.0 | ns |

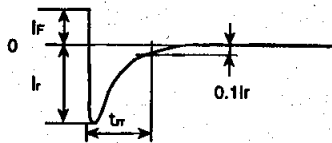
REVERSE RECOVERY TIME(t_{rr})TEST CIRCUIT



● INPUT VOLTAGE WAVE FORM

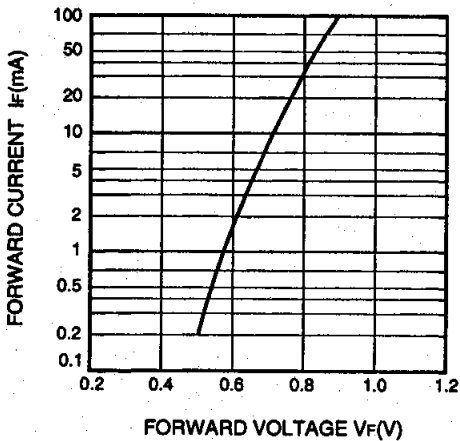


● CURRENT WAVE FORM IN DIODE

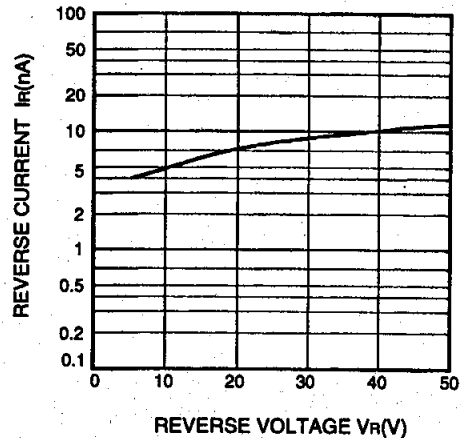


TYPICAL CHARACTERISTICS

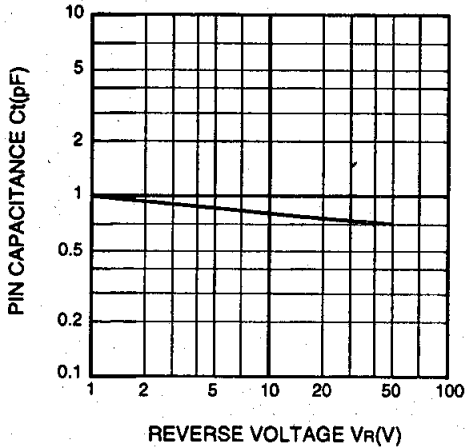
FORWARD CURRENT VS. FORWARD VOLTAGE



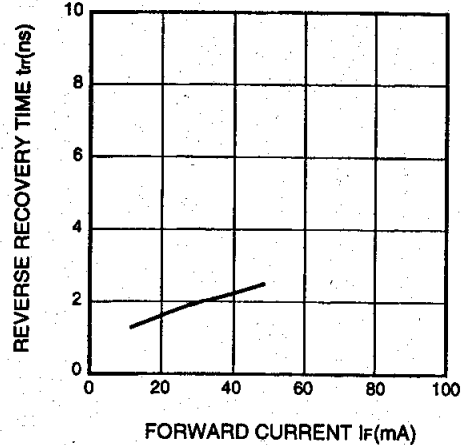
REVERSE CURRENT VS. REVERSE VOLTAGE



PIN CAPACITANCE VS. REVERSE VOLTAGE



REVERSE RECOVERY TIME VS. FORWARD CURRENT



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